

# Welcome to O-leading

O-Leading strives to be your one stop solution partner in EMS supply chain, including PCB design , PCB fabrication and PCB assembly (PCBA),We provide some of the most advanced PCB technology, including HDI PCBs,multilayer PCBs, Rigid-Flexible PCBs.We can support from quick turn prototype to medium & mass Production. [FR4 Rigid Double layer PCB manufacture China](#)

In general, our global customers are very impressed with our services:Rapid response, competitive price and quality commitment.Providing more valuable technical service and overall solution is the way O-leading forward.

Looking to the future, O-leading will concentrate on the innovation and development of electronics manufacturing technology as always, and make persistent efforts on PCB & PCBA one-stop service to provide first-class services and create more value for our customers.

PLEASE CLICK THESE FOR MORE INFORMATION [Green Solder Mask ENIG PCB Board](#)

**O-LEADING**  
To Be Reliable, To Be Valuable

WE ALWAYS PROVIDE YOU

**BEST HIGH DENSITY INTERCONNECT PCB**

**O-LEADING**  
To Be Reliable, To Be Valuable

WE ALWAYS PROVIDE YOU

**BEST RIGID-FLEXIBLE CIRCUIT**

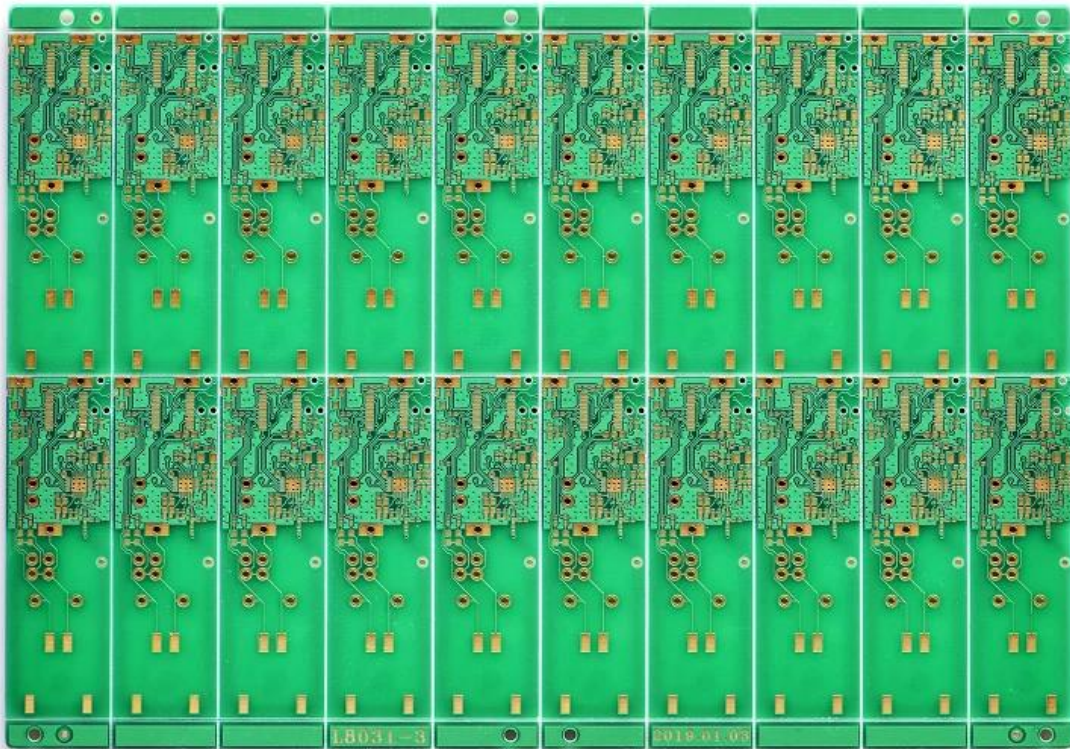
## Product Description

**O-LEADING**  
To Be Reliable, To Be Valuable

**QUALITY IS OUR CULTURE**



**O-LEADING**  
To Be Reliable, To Be Valuable



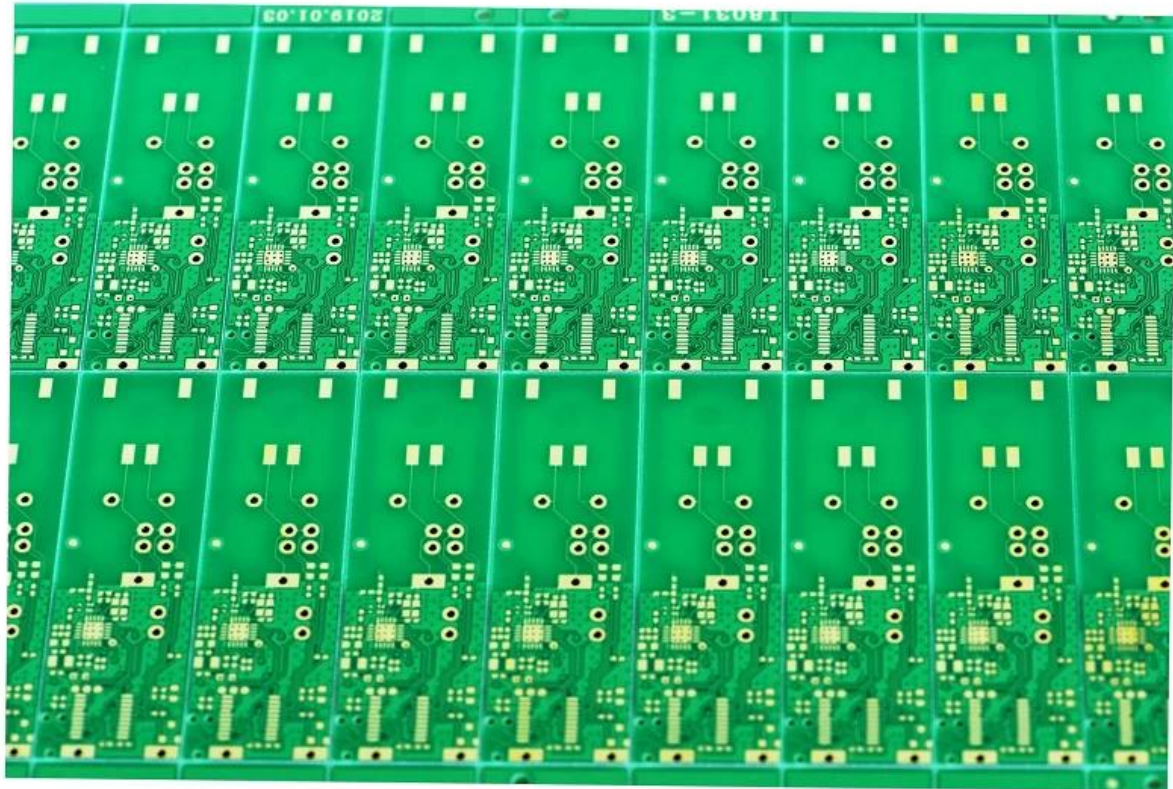
# O-LEADING

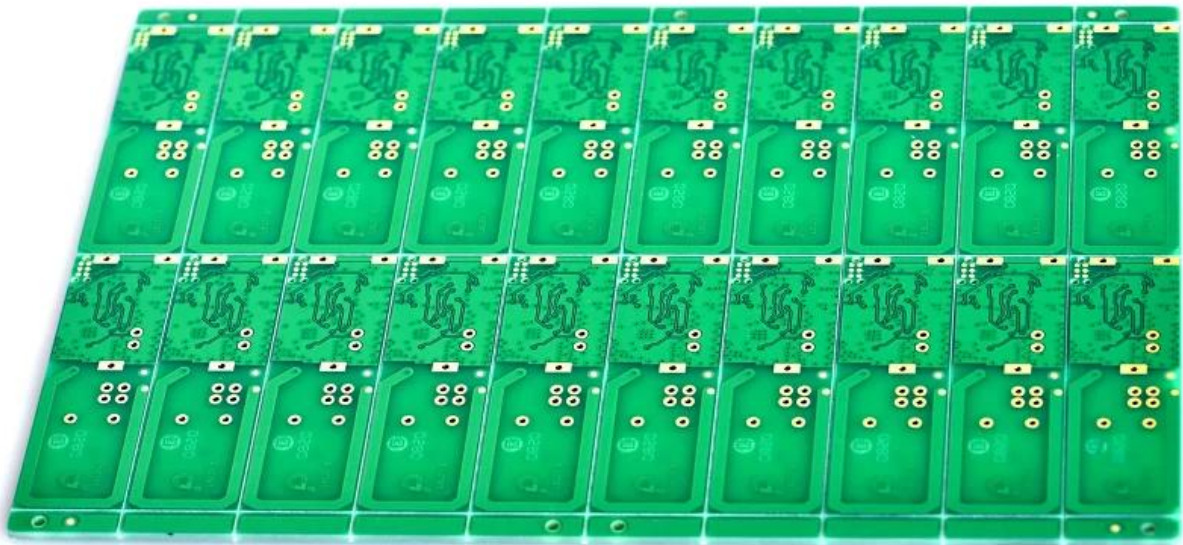
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# O-LEADING

To Be Reliable, To Be Valuable





# Production Process

18 years experience in one-stop PCB and PCBA, we can make your idea come true,



 CONSUMER ELECTRONICS

 AUTOMOTIVE ELECTRONICS

 INDUSTRIAL CONTROL

 INTELLECTUALIZED HOUSEHOLD CONTROL

 OTHER



**30%**  
CONSUMER ELECTRONICS



**18%**  
INTELLECTUALIZED HOUSEHOLD CONTROL

**20%**  
AUTOMOTIVE ELECTRONICS



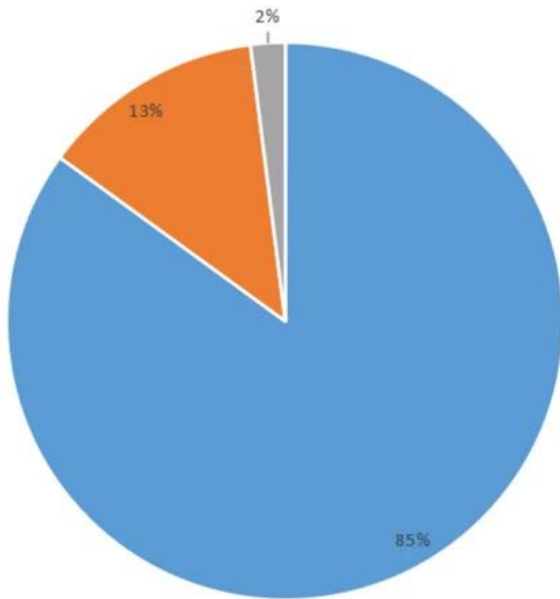
**12%**  
OTHER



**20%**  
INDUSTRIAL CONTROL



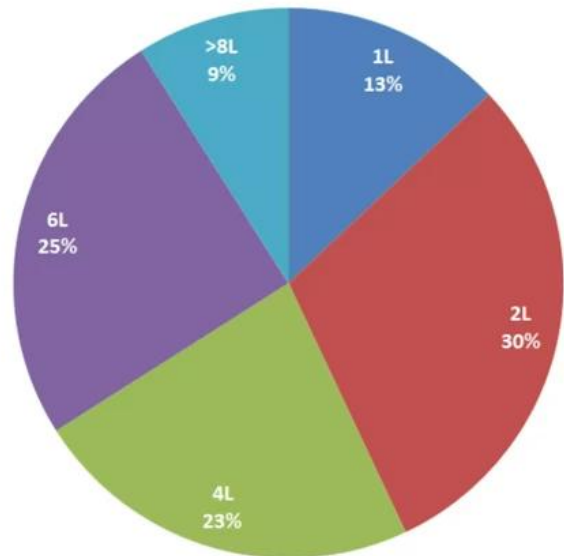
## Product types



■ FR-4 PCB ■ MC PCB ■ rigid-flexible PCB

## Product layers

■ 1L ■ 2L ■ 4L ■ 6L ■ >8L



## Our Team





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Factory PCB

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Automatic vacuum press machine



Drilling Machine



Pattern Plating Machine



Scrubbing Machine



Developing Machine



Routing Machine



High-speed flying probe machine



E-test Machine

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Factory SMT

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# Certifications

CICC INSPECTION CERTIFICATION



**嘉泰认证**

**QUALITY MANAGEMENT SYSTEM CERTIFICATE**

Certificate No: 18118Q10347R05

**We hereby certify that**

**O-LEADING SUPPLY CHAIN(HK) CO.,LIMITED**

Credit No: 61691591-000-07-18-7

Registration Add: FLAT/RM 1205 12/F TAI SANG BANK BUILDING 130-132 DES VODEUS ROAD CENTRAL HK

Business Add: 1213, Floor 13, Fortune Building, Danshui Town, Huiyang District, Huizhou, Guangdong, China

Has implemented and maintains a **Quality Management System** Which fulfills the requirements of the following standards  
GB/T19001-2016 idt ISO9001:2015

**Scope of certification**  
Sales of printed circuit boards

Initial issuance period: February 27, 2018  
Renewal date: April 22, 2019  
This certificate is valid during: April 22, 2019 – February 26, 2021  
This certificate is invalid without CICC qualified label in the following period

First supervision and audit	Second supervision and audit	Qualified mark
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The certification registration number does not include those production stages which fail to be covered by the relevant effective administrative procedures and qualification procedures mentioned in the scope. The effectiveness of this certificate shall be restricted to actual surveillance scope of CICC. The certificate shall be valid when used together with the qualified mark issued.

The initial issuance of this certification can be searched on the portal of CICC [www.cicc.com.cn](http://www.cicc.com.cn) by the code of inquiry [www.cicc.com.cn](http://www.cicc.com.cn).






CICC INSPECTION CERTIFICATION



**嘉泰认证**

**质量管理体系认证证书**

证书号: 18118Q10347R05

**兹证明**

**诚领供应链(香港)有限公司**

统一社会信用代码: 61691591-000-07-18-7

注册地址: 香港中環德輔道中130-132號大生銀行大廈1205室

经营地址: 广东惠州惠阳淡水南亨西路财富大厦13楼1313

**建立的质量管理体系符合**  
GB/T19001-2016 idt ISO9001:2015 质量标准适用条款的要求

**认证范围**  
印刷线路板的销售

初次获证日期: 2018年02月27日  
换证日期: 2019年04月22日  
证书有效期: 自2019年04月22日至2021年02月26日  
在下列期限内, 未经CICC黏贴合格标贴, 本证书无效

第一次监督	第二次监督	黏贴处
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## ZPMV2.E490354 - WIRING, PRINTED - COMPONENT

## Wiring, Printed - Component

See General Information for Wiring, Printed - Component

**O-LEADING SUPPLY CHAIN (HK) CO LTD**

E490354

ROOM 1205, 12/F  
TAI SANG BANK BLDG  
130-132 DES VOEUS ROAD  
CENTRAL, HONG KONG

Type	Cond Width			SS/ DS/ DSO	Max	Max			Meets UL796	C T	
	Min	Min	Cond		Area	Solder	Oper	Flame			
	mm(in)	Edge mm(in)	Thk mic(mil)		Diam mm(in)	Limits C sec	Temp C	Class			
<b>Multilayer (mass laminate) printed wiring boards.</b>											
<b>O-LEADING-401</b>	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	12.7 (0.5)	260	10	130	V-0	-	-
<b>O-LEADING-407</b>	0.08 (0.003)	0.2 (0.008)	17 (0.67)	DS	9.7 (0.4)	260	10	130	V-0	All	-
<b>Multilayer printed wiring boards.</b>											
<b>O-LEADING-408</b>	0.125 (0.005)	0.125 (0.005)	12 (0.47) Int:136	DS	50.8 (2.0)	280	20	130	V-0	All	*
<b>Single layer printed wiring boards.</b>											
<b>O-LEADING-002</b>	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	105	V-0	All	-
<b>O-LEADING-003</b>	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	130	V-0	▲	-
<b>O-LEADING-033</b>	0.15 (0.006)	0.3 (0.012)	34 (1.34)	SS	25.4 (1.0)	260	10	120	V-0	All	-
<b>O-LEADING-205</b>	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	69.6 (2.7)	260	10	130	V-0	All	-
<b>O-LEADING-206</b>	0.15 (0.006)	0.33 (0.013)	17 (0.67)	DS	69.6 (2.7)	260	10	130	V-0	All	-
<b>O-LEADING-D01</b>	0.14 (0.006)	0.15 (0.006)	33 (1.30)	DS	25.4 (1.0)	260	10	130	V-0	All	*
<b>O-LEADING-S01</b>	0.25 (0.010)	0.25 (0.010)	17 (0.67)	SS	25.4 (1.0)	260	4	130	V-0	All	*

## WIRING, PRINTED - COMPONENT | UL Product iQ

<b>O-LEADING-S02</b>	0.2 (0.008)	0.2 (0.008)	17 (0.67)	SS	25.4 (1.0)	260	4	130	HB	▲	*
<b>O-LEADING-S03</b>	0.25 (0.010)	0.25 (0.010)	34 (1.34)	SS	25.4 (1.0)	260	4	130	V-0	All	*

\* - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or burning test classification.

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# Process Capability

## PCB Production Capabilities

Layer Count	1Layer-32Layer
Finished copper thickness	1/3oz-12oz
Min Line width/spacing internal	3.0mil/3.0mil
Min Line width/spacing external	4.0mil/4.0mil
Max Aspect Ratio	10:1
Board thickness	0.2mm-5.0mm
Max Panel size(inches)	635*1500mm
Minimum Drilled Hole Size	4mil
Plated Hole Tolerance	+/-3mil
Blind/Buried Vias (All Types)	YES
Via Fill(Conductive,Non-Conductive)	YES
Base Material	FR-4,FR-4high Tg,Halogen free material,Rogers,Aluminium base,Polyimide,Heavy Copper
Surface finishes	HASL,OSP,ENIG,HAL-LF,Immersion silver,Immersion Tin,Gold fingers,Carbon ink

## SMT Production Capabilities

PCB Material	FR-4,CEM-1,CEM-3,Aluminum-based board
Max PCB size	510x460mm
Min PCB size	50x50mm
PCB Thickness	0.5mm-4.5mm
Board thickness	0.5-4mm
Min Components size	0201
Standard chip size component	0603 and larger
Component max height	15mm
Min lead pitch	0.3mm
Min BGA ball pitch	0.4mm
Placement precision	+/-0.03mm

# Packaging & Delivery

# Shipping service



Quick Turn Lead Time		
Layer Count:	Lead Tim	Special Requirement
1L/2L	2-3days	24 Hours,48 Hours
4L	3-4days	48 Hours
6L	4-5days	72 Hours
8L	5-6days	NA
10L	6-7days	NA
12L	7-8days	NA
14L	8-9days	NA

Standard Lead Time		
Layer Count:	Sample Lead Time	Volume order lead time
2L	4 days	10 days
4L	5 days	11 days
6L	6 days	12 days
8L	8 days	14 days
10L	10 days	16 days
12L	12 days	18 days
14L	14 days	20 days
16-32L	18 days	24 days

## FAQ

### 1. How do O-Leading ensure quality?

Our high quality standard is achieved with the following.

1.1 The process is strictly controlled under ISO 9001:2008 standards.

1.2 Extensive use of software in managing the production process

1.3 State-of-art testing equipments and tools. E.g. Flying Probe, X-ray Inspection, AOI (Automated Optical Inspector) and ICT (in-circuit testing).

1.4.Dedicated quality assurance team with failure case analysis process

1.5.Continuous staff training and education

### 2. How do O-Leading keep your price competitive?

Over the last decade, prices of many raw materials (e.g. copper, chemicals) had doubled, tripled or quadrupled; Chinese currency RMB had appreciated 31% over US dollar; And our labor cost also increased significantly.

However, O-Leading have kept our pricing steady. This owns entirely to our innovations in reducing cost, avoiding wastes and improving efficiency. Our prices are very competitive in the industry at the same quality level.

We believe in a win-win partnership with our customers. Our partnership will be mutually beneficial if we can provide you an edgeon cost and quality.

### **3. What kinds of boards can O-Leading process?**

Common FR4, high-TG and halogen-free boards, Rogers, Arlon, Telfon, aluminum/copper-based boards, PI, etc.

### **4. What data are needed for PCB & PCBA production?**

4.1 BOM (Bill of Materials) with reference designators: component description, manufacturer's name and part number.

4.2 PCB Gerber files.

4.3 PCB fabrication drawing and PCBA assembly drawing.

4.4 Test procedures.

4.5 Any mechanical restrictions such as assembly height requirements.

### **5. What's the typical process flow for multi-layer PCB?**

Material cutting → Inner dry film → inner etching → Inner AOI → Multi-bond → Layer stack up Pressing → Drilling → PTH → Panel Plating → Outer Dry Film → Pattern Plating → Outer etching → Outer AOI → Solder Mask → Component Mark → Surface finish → Routing → E/T → Visual Inspection.

### **6. What's the key equipments for HDI manufacturing?**

Key equipment list is as following: Laser drilling machine, Pressing machine, VCP line, Automatic Exposing machine, LDI and etc.

The equipments we have are the best in the industry, laser drilling machines are from Mitsubishi and Hitachi, LDI machines are from Screen(Japan), Automatic Exposing machines are also from Hitachi, all of them make we can meet customer's technical requirements.

### **7. How many types of surface finish O-lead can do?**

O-the leader has the full series of surface finish, such as: ENIG, OSP, LF-HASL, gold plating (soft/hard), immersion silver, Tin, silver plating, immersion tin plating, carbon ink and etc. .. OSP, ENIG, OSP + ENIG commonly used on the HDI, we usually recommend that you use a client or OSP OSP + ENIG if BGA PAD size less than 0.3 mm.

### **8. What's your capability for FPC? Can O-Leading provide SMT service also?**

O-Leading can fabricate FPC from single layer to 8layer, the working panel size can be as large as 2000mm\*240mm, please find the details in the page "Flex Capability"

We also provide SMT one stop service to customer.

### **9. What are the main factors which will affect the price of PCB?**

Material;

Surface finish;

Technology difficulty;

Different quality criteria;

PCB characteristics;

Payment terms;

Different manufacturing countries.

### **10. What's the definition of PCB, PWB and FPC and what's the difference?**

PCB is short for Printed Circuit Board;

PWB is short for Printed Wire Board, same meaning as Printed Circuit Board;

FPC is short for Flexible Printed Board.

### **11. What factors should be considered when choosing the material for a PCB board?**

Below factors should be considered when we choose the material for PCB:

The material's Tg value should be greater than the operation temperature;

Low CTE material has good performance of thermal stability;



Good thermal resistance performance: Normally PCBs are required to resist 250°C for at least 50s.  
Good flatness; In consideration of the electrical properties, low loss/high permittivity material is used on high frequency PCB; Polyimide glass fiber substrate used for flexible PCB; Metal core is used when the product has strict requirement of heat dissipation.

### **12. What's the merits of O-leading's rigid-flex PCB?**

O-leading's rigid-flex PCB has the characters of both FPC and PCB, so it can be used in some special products. Some part is flexible while the other part rigid, it can help save product's interior space, reduce product volume and improve performance.

### **13. How to you make the impedance calculation?**

The impedance control system is done using some test coupons, the SI6000 soft and the CITS 500s equipment from POLAR INSTRUMENTS.

The equipment measures the impedance on a representative track configuration coupon of which the client has given us a determinate value and tolerance.